

GBU8005~GBU810

202

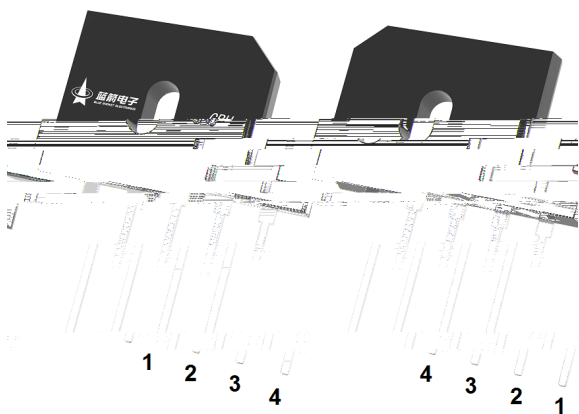
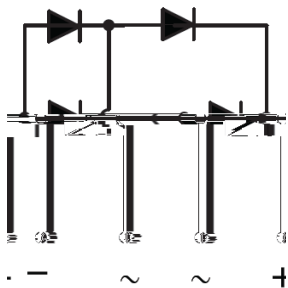
8.0A
80

50~1000V GBU

: 0 1000

9 0

9 0



1 2 3

1

:

		800	801	802	80	806	808	810	
		0	100	200	00	600	800	1000	
		3	70	1 0	280	20	60	700	
		0	100	200	00	600	800	1000	
=100 ()	()	8 0							
()		17							

(<8 3)

2

127

2 =100

/ Electrical Characteristic Curve

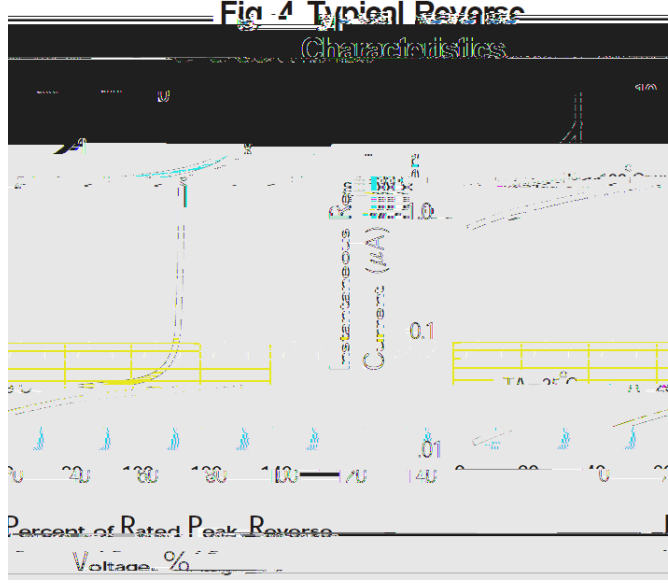
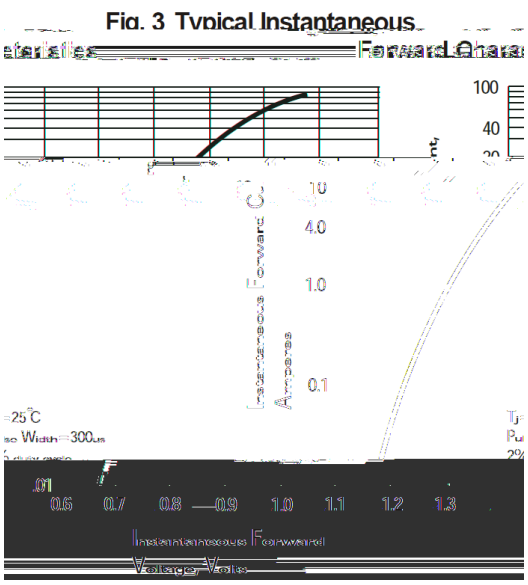
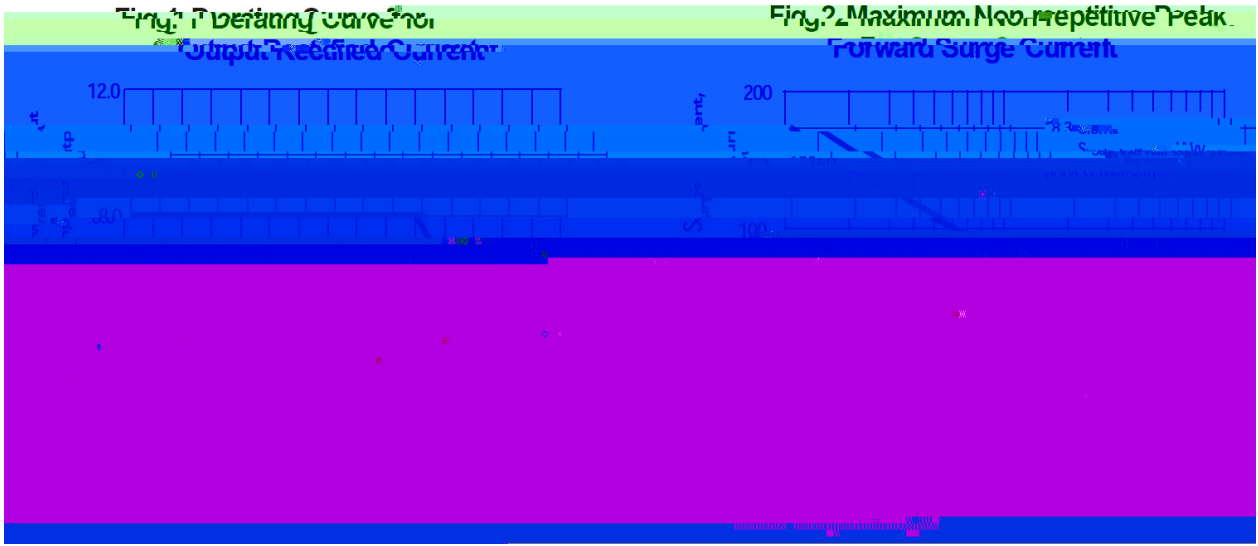
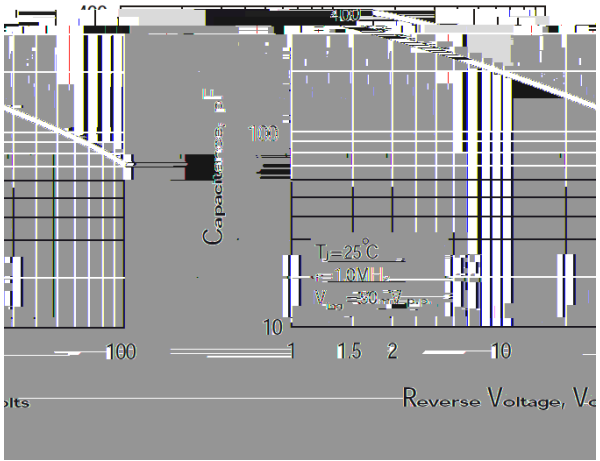
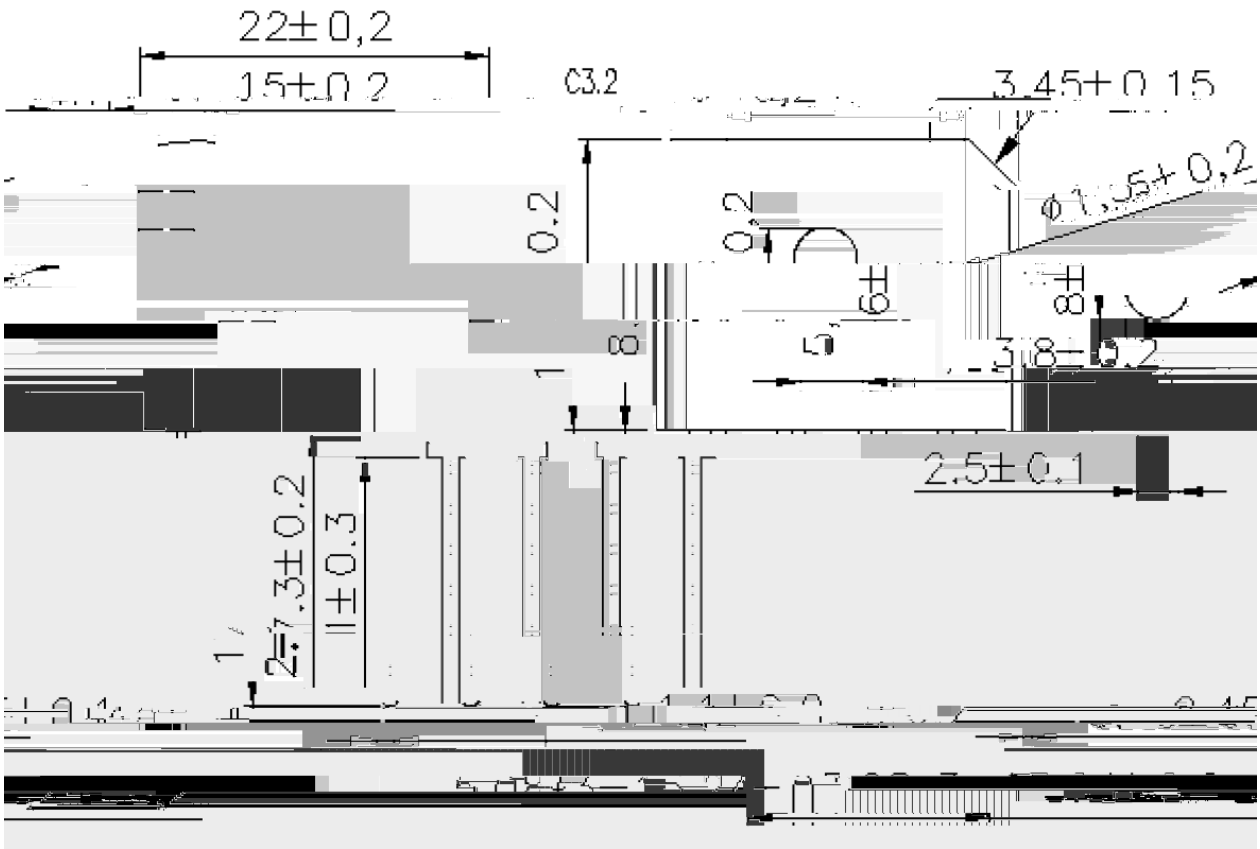


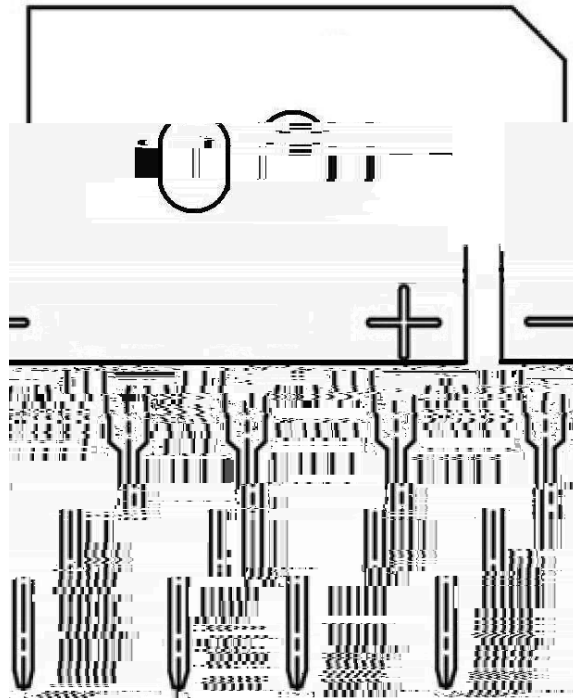
Fig. 5 Typical Junction Capacitance



/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)

:

1	2	1 0	60 90	;	1	:2	1 0	:60 90
2	2	±	±0	;	2	:2	±	: ±0
3			2 10		3		:2 10	

/ Resistance to Soldering Heat Test Conditions

270±	10±1	:270	:10 1
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/ Packaging SPEC.